

## 1 CLAIMS

2 What we claim as our invention:

3 1. A system for the treatment of effluent gases from a semiconductor

4 device manufacturing process, the system comprising:

5 (a) a burn/wet scrubber for receiving a flow of effluent gas

6 containing a toxic constituent and for producing a flow of treated gas and a flow

7 of waste-water containing the toxic constituent; and

8 (b) a local waste water treatment unit associated with the

9 burn/wet scrubber for receiving the flow of wastewater containing the toxic

10 constituent and for producing a flow of locally treated wastewater from which the

11 toxic constituent has been abated.

1 2. The system of claim 1 further comprising a plurality of burn/wet

2 scrubbers in fluid communication with a single local wastewater treatment unit.

1 3. (a) The system of claim 1 wherein said wastewater treatment

2 unit includes an ion exchange filter.

1 4. 3. The system of claim 3 wherein said toxic constituents include

2 arsine and germanium by-products produced from a chemical vapor deposition

3 process and said ion exchange filter abates the concentration said arsine and

4 germanium in the wastewater.

1 5. The system of claim 1 and including a central wastewater treatment

2 facility for receiving and further treating the locally treated wastewater.

SUB cat

1        5. The system of claim 1 further comprising a plurality of burn/wet  
2        scrubbers and a plurality of wastewater treatment units wherein each burn/wet  
3        scrubbers is in fluid communication with a corresponding wastewater treatment  
4        unit, and each said wastewater treatment unit is in fluid communication with the  
5        central wastewater treatment facility.

1        7        6. A method for the abatement of toxic constituents of effluent gases  
2        discharged during the manufacture of semiconductor devices, the method  
3        comprising the steps of:

- 4              (a) oxidizing the toxic constituents of the effluent gases;
- 5              (b) condensing the oxidized toxic constituents with water; and
- 6              (c) abating condensed toxic constituents from water used to  
7        condense the oxidized toxic constituents.

1        8        7. The method of claim 7 wherein said step of abating the toxic  
2        constituents from the water includes providing an ion exchange filter for the  
3        filtration of toxic constituents from the water.

1        9        8. The method of claim 7 wherein the steps of oxidizing the toxic  
2        constituents and condensing the oxidized toxic constituents take place at a  
3        plurality of locations during the manufacture of the semiconductor devices.

1        10       9. The method of claim 7 and including the step of directing the water  
2        to a central wastewater treatment facility after the abatement of the toxic  
3        constituents.

1           10. The method of claim 10 wherein said step of abating the toxic  
2 constituents from the water includes providing a plurality of ion exchange filters  
3 for the filtration of toxic compounds from the water, before the water is directed to  
4 the central wastewater treatment facility.

1           11. A method of abatement of toxic constituents in the effluent from a  
2 semiconductor device manufacturing process, the method comprising:  
3               (a) treating a flow of effluent gas containing a toxic constituent in  
4 a burn/wet scrubber to produce a flow of treated gas and a flow of wastewater  
5 containing the toxic constituent; and,  
6               (b) locally treating the flow of wastewater containing the toxic  
7 constituent to produce a flow of locally treated wastewater from which the toxic  
8 constituent has been abated.

1           12. The method of claim 10 further including the step of treating the  
2 wastewater in a central wastewater treatment facility subsequent to said step of  
3 locally treating the wastewater.

1           13. The method of claim 10 wherein said step of locally treating the  
2 wastewater includes flowing the wastewater through an ion exchange filter.

Subj

Addas